

N-Channel 60 V (D-S) MOSFET



RoHS
COMPLIANT

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A) ^a	Q _g (Typ.)
60	4.0 at V _{GS} = 10 V	72	38 nC
	5.7 at V _{GS} = 4.5 V		

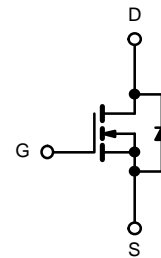
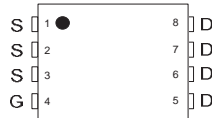
FEATURES

- DT-SJ Power MOSFET
- 100 % Rg and UIS tested
- AEC-Q101 Qualified for Automotive Applications

APPLICATIONS

- Notebook PC Core
- VRM/POL

DFN5X6-8L Pin Configuration



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	60	V
Gate-Source Voltage	V _{GS}	± 20	
Continuous Drain Current (T _J = 175 °C) ^a	I _D	T _C = 25 °C	72
		T _C = 100 °C	59
Pulsed Drain Current ^b	I _{DM}	280	A
Single Avalanche Energy	E _{AS}	205	mJ
Maximum Power Dissipation ^c	P _D	T _C = 25 °C	108
		T _C = 100 °C	54
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-Ambient (PCB Mount) ^d	R _{thJA}	55	°C/W
Junction-to-Case (Drain)	R _{thJC}	1.38	

Notes

- Calculated continuous current based on maximum allowable junction temperature.
- Repetitive rating; pulse width limited by max. junction temperature.
- P_D is based on max. junction temperature, using junction-case thermal resistance.
- The value of R_{thJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.

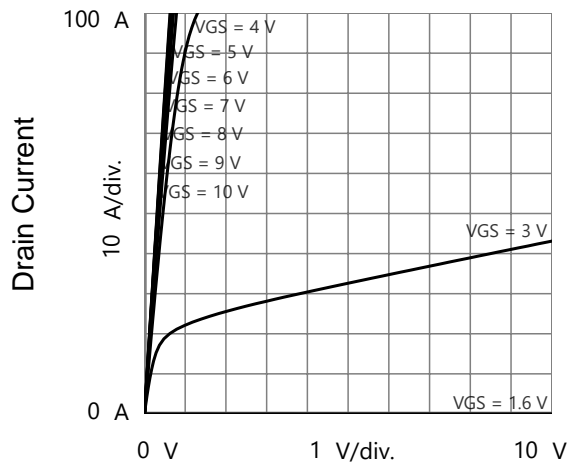
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	60	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1	-	3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	72	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A	-	4.0	4.8	mΩ
		V _{GS} = 4.5 V, I _D = 10 A	-	5.7	7.5	
Forward Transconductance ^a	g _{fs}	V _{DS} = 4.5 V, I _D = 10 A	-	60	-	S
Dynamic^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz	-	2220	-	pF
Output Capacitance	C _{oss}		-	585	-	
Reverse Transfer Capacitance	C _{rss}		-	8	-	
Total Gate Charge ^c	Q _g	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 10 A	-	38	-	nC
Gate-Source Charge ^c	Q _{gs}		-	4.3	-	
Gate-Drain Charge ^c	Q _{gd}		-	6.4	-	
Gate Resistance	R _g	f = 1 MHz	-	1.8	-	Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, R _{GEN} = 3 Ω, V _{GS} = 10 V, I _D = 10 A	-	10	-	ns
Rise Time ^c	t _r		-	13	-	
Turn-Off Delay Time ^c	t _{d(off)}		-	30	-	
Fall Time ^c	t _f		-	15	-	
Drain-Source Body Diode Ratings and Characteristics^b (T_J = 25 °C)						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	72	A
Pulsed Current	I _{SM}		-	-	280	A
Forward Voltage ^a	V _{SD}	I _F = 1 A, V _{GS} = 0 V	-	0.7	-	V
Reverse Recovery Time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs	-	33	-	ns
Reverse Recovery Charge	Q _{rr}		-	31	-	nC

Notes

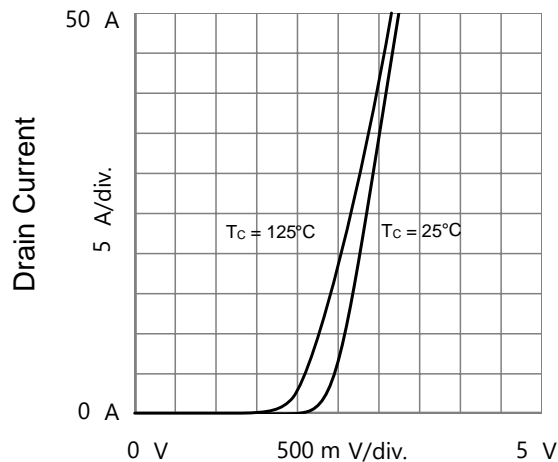
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

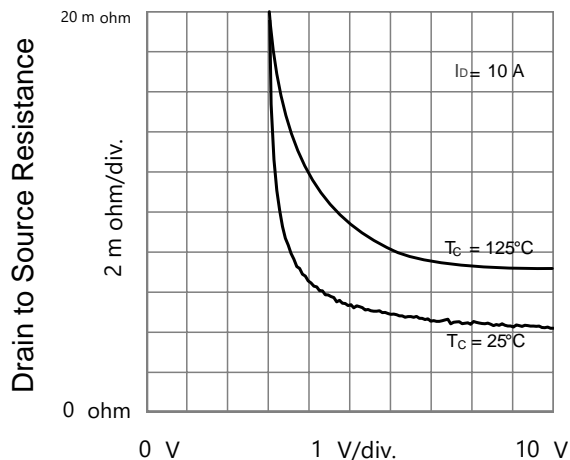
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



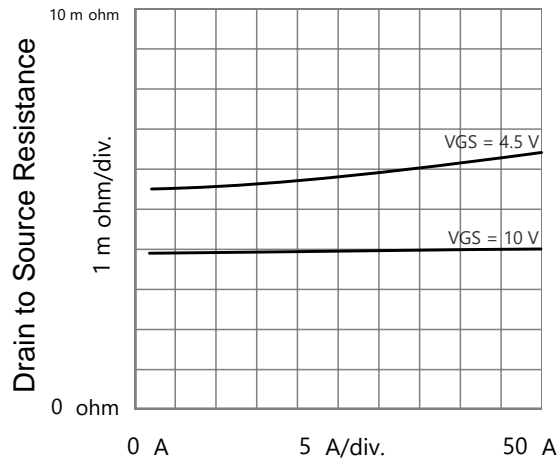
Drain to Source Voltage
Output Characteristics



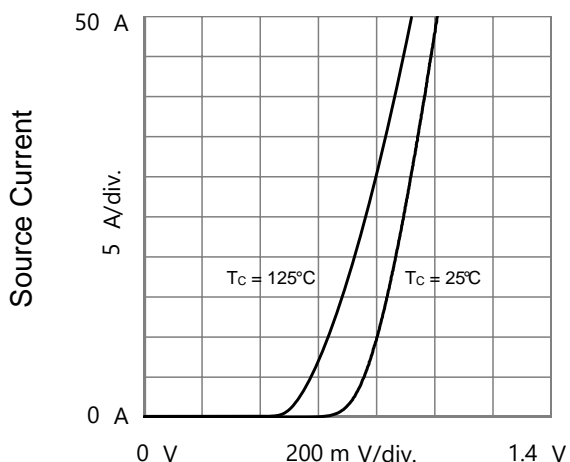
Gate to Source Voltage
Transfer Characteristics



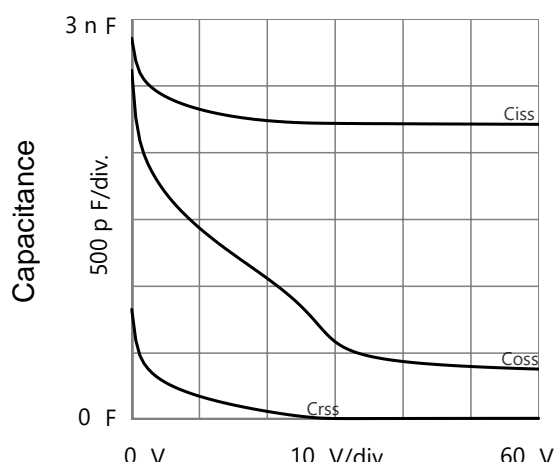
Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage



Drain Current
Drain to Source Resistance vs. Drain Current

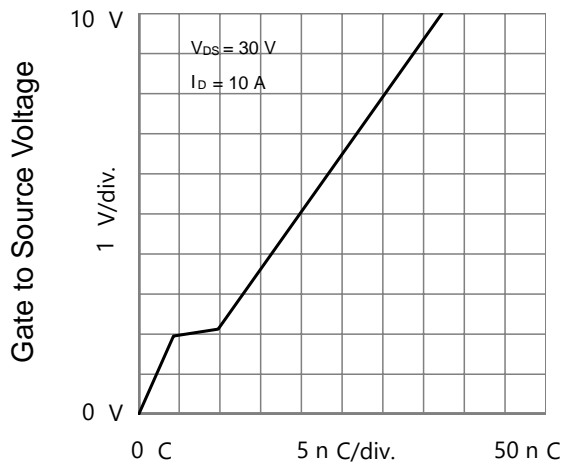


Source to Drain Voltage
Body Diode Forward Characteristics

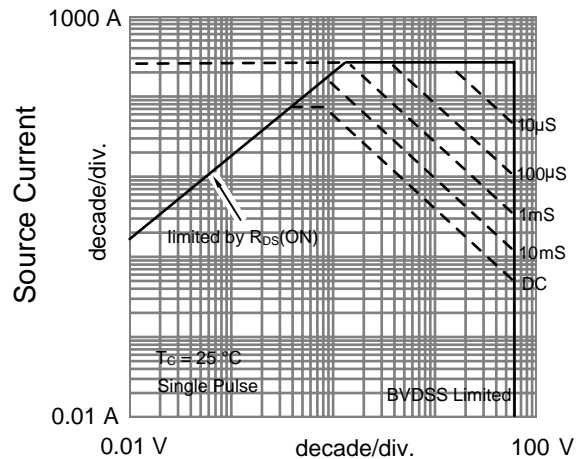


Drain to Source Voltage
Capacitances

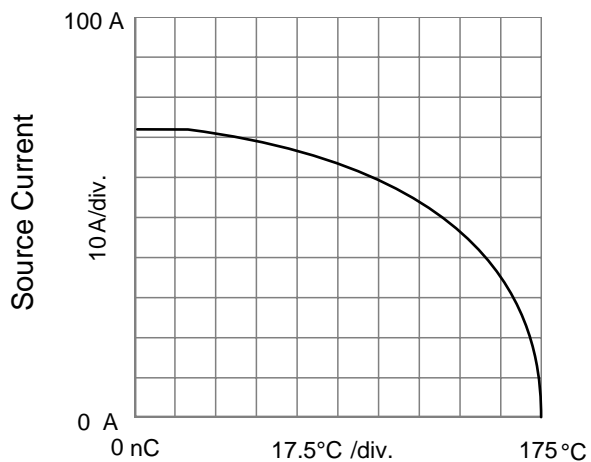
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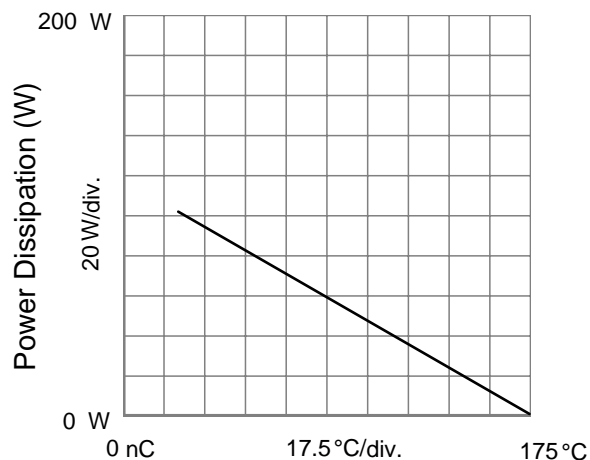
Gate Charge
Gate to Source Voltage vs. Gate Charge



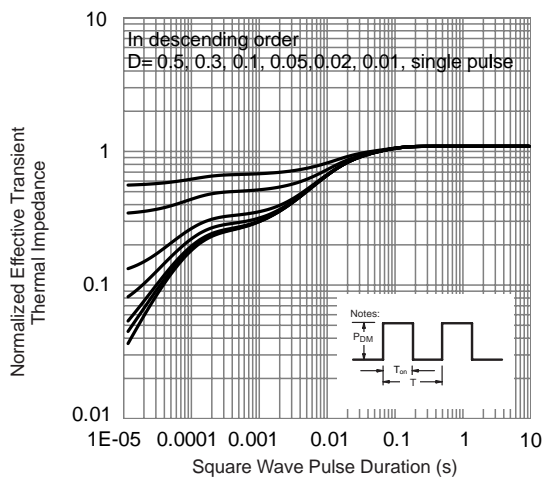
Source to Drain Voltage
Safe Operating Area, Junction-to-Case



T_c - Case Temperature

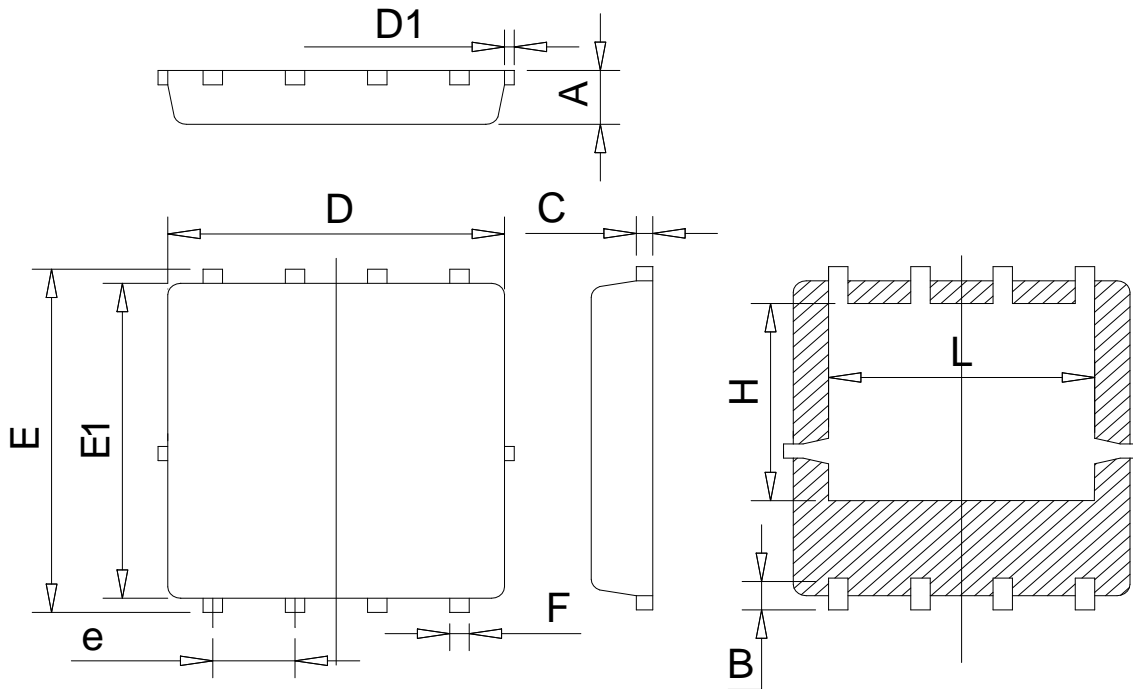


T_c - Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

DFN5X6-8L PACKAGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Typ	Max
A	0.78	0.95	1.12
B	0.45	0.58	0.78
C	0.18	0.254	0.36
D	4.70	5.20	5.45
D1			0.18
E	5.85	6.05	6.25
E1	5.38	5.55	5.98
e	1.15	1.27	1.40
F	0.18	0.30	0.52
H	3.25	3.47	3.70
L	3.75	4.00	4.25

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